

**OPA2541**

## Dual High Power OPERATIONAL AMPLIFIER

### FEATURES

- OUTPUT CURRENTS TO 5A
- POWER SUPPLIES TO  $\pm 40V$
- FET INPUT
- ELECTRICALLY ISOLATED CASE

### APPLICATIONS

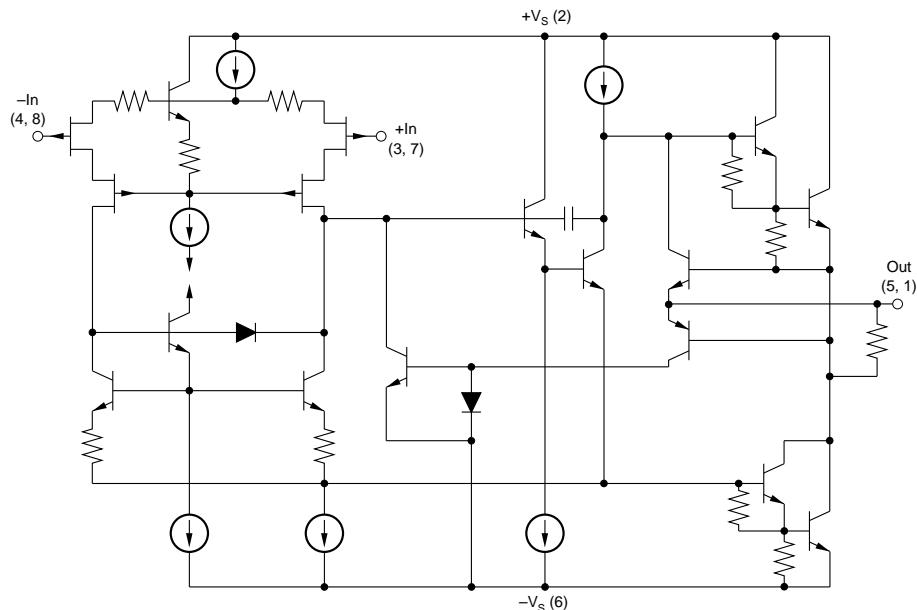
- MOTOR DRIVER
- SERVO AMPLIFIER
- SYNCRO/RESOLVER EXCITATION
- VOICE COIL DRIVER
- BRIDGE AMPLIFIER
- PROGRAMMABLE POWER SUPPLY
- AUDIO AMPLIFIER

### DESCRIPTION

The OPA2541 is a dual power operational amplifier capable of operation from power supplies up to  $\pm 40V$  and output currents of 5A continuous. With two monolithic power amplifiers in a single package it provides unequalled functional density.

The industry-standard 8-pin TO-3 package is isolated from all internal circuitry allowing it to be mounted directly to a heat sink without insulators which degrade thermal performance. Internal circuitry limits output current to approximately 6A.

The OPA2541 is available in both industrial and military temperature range versions.



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# SPECIFICATIONS

## ELECTRICAL

At  $T_C = +25^\circ\text{C}$  and  $V_S = \pm 35\text{VDC}$ , unless otherwise noted.

PARAMETER	CONDITIONS	OPA2541AM			OPA2541BM, SM			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
<b>INPUT OFFSET VOLTAGE</b>								
$V_{OS}$ vs Temperature vs Supply Voltage vs Power	Specified Temperature Range $V_S = \pm 10\text{V}$ to $\pm V_{MAX}$		$\pm 2$ $\pm 20$ $\pm 2.5$ $\pm 20$	$\pm 10$ $\pm 40$ $\pm 10$ $\pm 60$		$\pm 0.25$ $\pm 15$ *	$\pm 1$ $\pm 30$ *	$\text{mV}$ $\mu\text{V}/^\circ\text{C}$ $\mu\text{V}/\text{V}$ $\mu\text{V}/\text{W}$
<b>INPUT BIAS CURRENT</b>								
$I_B$	Specified Temperature Range		15 Note 1	50		*	*	pA
<b>INPUT OFFSET CURRENT</b>								
$I_{OS}$	Specified Temperature Range		$\pm 5$ Note 1	$\pm 30$		*	*	pA
<b>INPUT CHARACTERISTICS</b>								
Common-Mode Voltage Range Common-Mode Rejection Input Capacitance Input Impedance, DC	Specified Temperature Range $V_{CM} = ( \pm V_S  - 6\text{V})$	$\pm( V_S  - 6)$ 95	$\pm( V_S  - 3)$ 106 5 1		*	*		$\text{V}$ $\text{dB}$ $\text{pF}$ $10^{12}\Omega$
<b>GAIN CHARACTERISTICS</b>								
Open Loop Gain at 10Hz Gain-Bandwidth Product	$R_L = 6\Omega$	90	96 1.6		*	*		$\text{dB}$ MHz
<b>OUTPUT</b>								
Voltage Swing Current, Continuous	$I_O = 5\text{A}$ $I_O = 2\text{A}$ $I_O = 0.5\text{A}$ $+25^\circ\text{C}$ $+85^\circ\text{C}$ $+125^\circ\text{C}$ (SM grade only)	$\pm( V_S  - 5.5)$ $\pm( V_S  - 4.5)$ $\pm( V_S  - 4)$	$\pm( V_S  - 4.5)$ $\pm( V_S  - 3.6)$ $\pm( V_S  - 3.2)$		*	*		$\text{V}$ $\text{V}$ $\text{V}$ $\text{A}$ $\text{A}$ $\text{A}$
<b>AC PERFORMANCE</b>								
Slew Rate Power Bandwidth Settling Time to 0.1%	$R_L = 8\Omega$ , $V_O = 20\text{Vrms}$ 2V Step	6 45	8 55 2		*	*		$\text{V}/\mu\text{s}$ $\text{kHz}$ $\mu\text{s}$
Capacitive Load Phase Margin Channel Separation	Specified Temperature Range, $G = 1$ Specified Temperature Range, $G > 10$ Specified Temperature Range, $R_L = 8\Omega$ 1kHz, $R_L = 6\Omega$			3.3 SOA			*	nF
<b>POWER SUPPLY</b>								
Power Supply Voltage, $\pm V_S$ Current, Quiescent	Specified Temperature Range Total—Both Amplifiers	$\pm 10$ 40	$\pm 30$ 50	$\pm 35$	*	$\pm 35$ *	$\pm 40$ *	$\text{V}$ mA
<b>THERMAL RESISTANCE</b>								
$\theta_{JC}$ , (Junction-to-Case) $\theta_{JC}$ $\theta_{JC}$ $\theta_{JC}$ $\theta_{JA}$ , (Junction-to-Ambient)	Both Amplifiers <sup>(2)</sup> , AC Output $f > 60\text{Hz}$ Both Amplifiers <sup>(2)</sup> , DC Output One Amplifier, AC Output $f > 60\text{Hz}$ One Amplifier, DC Output No Heat Sink		0.8 0.9 1.25 1.4 30	1.0 1.2 1.5 1.9		*	*	$^\circ\text{C}/\text{W}$ $^\circ\text{C}/\text{W}$ $^\circ\text{C}/\text{W}$ $^\circ\text{C}/\text{W}$ $^\circ\text{C}/\text{W}$
<b>TEMPERATURE RANGE</b>								
Case	AM, BM SM	-25		+85	*	-55	*	$^\circ\text{C}$ $^\circ\text{C}$

<sup>\*</sup>Specification same as OPA2541AM.

NOTES: (1) Input bias and offset current approximately doubles for every  $10^\circ\text{C}$  increase in temperature. (2) Assumes equal dissipation in both amplifiers.

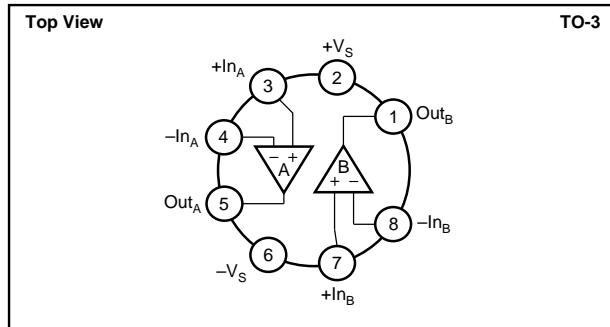
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## ABSOLUTE MAXIMUM RATINGS

Supply Voltage, $+V_S$ to $-V_S$ .....	80V
Output Current .....	see SOA
Power Dissipation, Internal <sup>(1)</sup> .....	125W
Input Voltage: Differential .....	$\pm V_S$
Common-mode .....	$\pm V_S$
Temperature: Pin Solder, 10s .....	+300°C
Junction <sup>(1)</sup> .....	+150°C
Temperature Range:	
Storage .....	-65°C to +150°C
Operating (Case) .....	-55°C to +125°C

NOTE: (1) Long term operation at the maximum junction temperature will result in reduced product life. Derate internal power dissipation to achieve high MTTF.

## CONNECTION DIAGRAM



## PACKAGE INFORMATION

MODEL	PACKAGE	PACKAGE DRAWING NUMBER <sup>(1)</sup>
OPA2541AM	TO-3	030
OPA2541BM	TO-3	030
OPA2541SM	TO-3	030

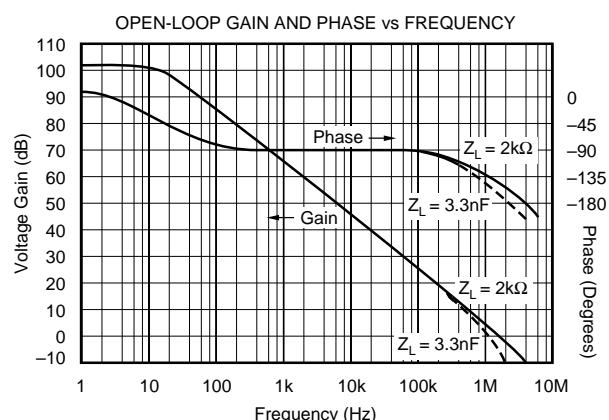
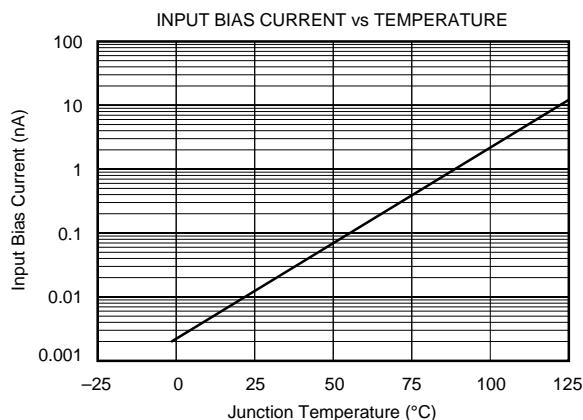
NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix D of Burr-Brown IC Data Book.

## ORDERING INFORMATION

MODEL	PACKAGE	TEMPERATURE RANGE
OPA2541AM	TO-3	-25°C to +85°C
OPA2541BM	TO-3	-25°C to +85°C
OPA2541SM	TO-3	-55°C to +125°C

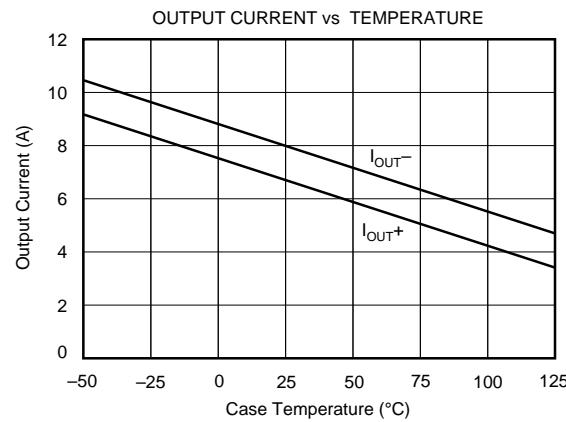
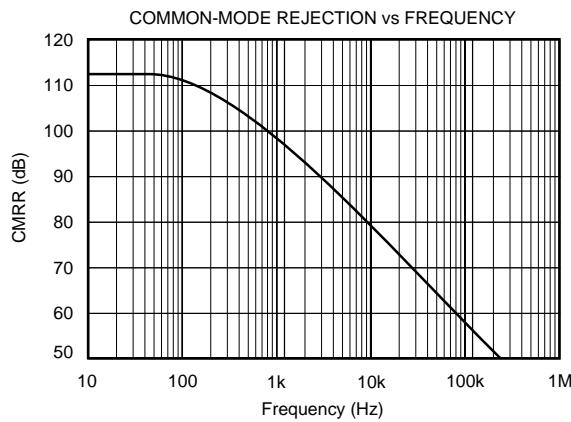
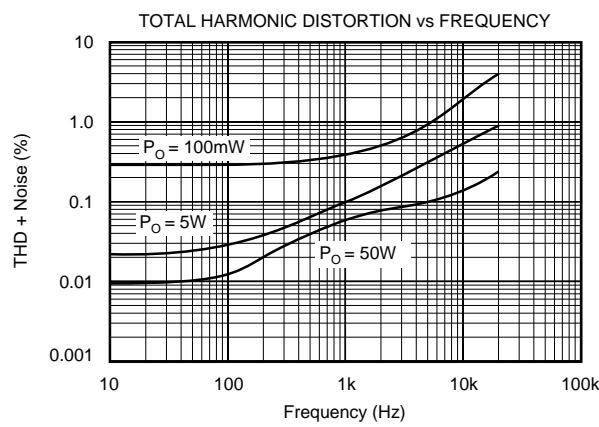
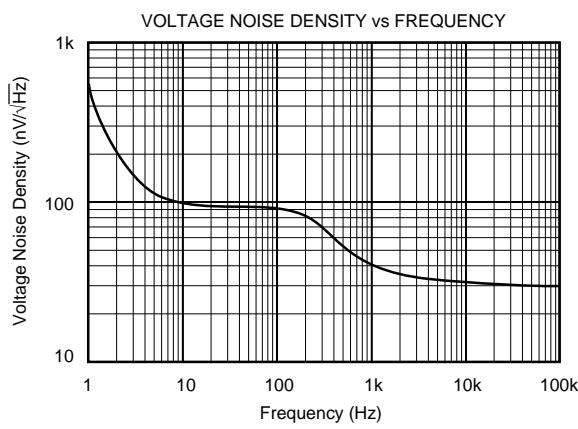
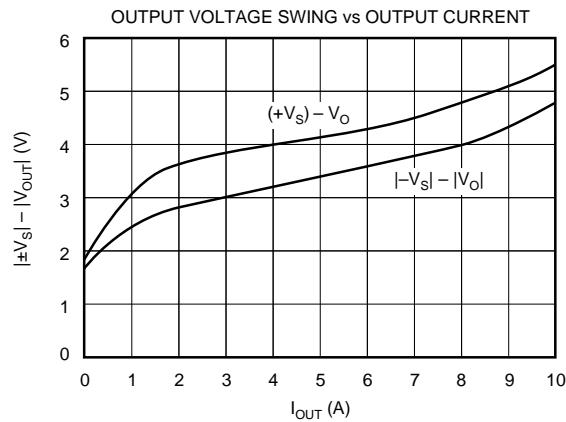
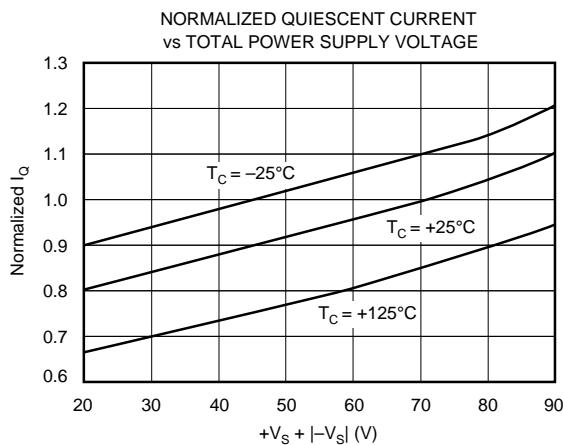
## TYPICAL PERFORMANCE CURVES

$T_A = +25^\circ\text{C}$  and  $V_S = \pm 35\text{VDC}$ , unless otherwise noted.



## TYPICAL PERFORMANCE CURVES (CONT)

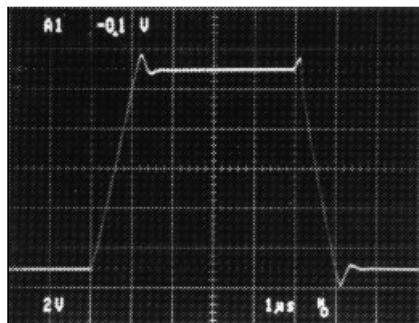
$T_A = +25^\circ\text{C}$  and  $V_S = \pm 35\text{VDC}$ , unless otherwise noted.



## TYPICAL PERFORMANCE CURVES (CONT)

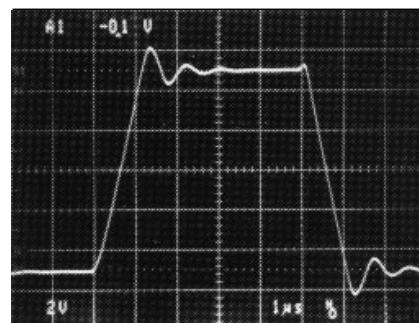
$T_A = +25^\circ\text{C}$  and  $V_S = \pm 35\text{VDC}$ , unless otherwise noted.

DYNAMIC RESPONSE



$Z_{\text{LOAD}} = \infty, V_S = \pm 35\text{V}, A_V = +1$

DYNAMIC RESPONSE



$Z_{\text{LOAD}} = 4700\text{pF}, V_S = \pm 35\text{V}, A_V = +1$

## INSTALLATION INSTRUCTIONS

### POWER SUPPLIES

The OPA2541 is specified for operation from power supplies up to  $\pm 40\text{V}$ . It can also be operated from an unbalanced or a single power supply so long as the total power supply voltage does not exceed  $80\text{V}$  ( $70\text{V}$  for "AM" grade). The power supplies should be bypassed with low series impedance capacitors such as ceramic or tantalum. These should be located as near as practical to the amplifier's power supply pins. Good power amplifier circuit layout is, in general, like good high-frequency layout. Consider the path of large power supply and output currents. Avoid routing these connections near low-level input circuitry to avoid waveform distortion and instability.

Signal dependent load current can modulate the power supply voltage with inadequate power supply bypassing. This can affect both amplifiers' outputs. Since the second amplifier's signal may not be related to the first, this will degrade the inherent channel separation of the OPA2541.

### HEAT SINKING

Most applications will require a heat sink to prevent junction temperatures from exceeding the  $150^\circ\text{C}$  maximum rating. The type of heat sink required will depend on the output signals, power dissipation of each amplifier, and ambient temperature. The thermal resistance from junction-to-case,  $\theta_{\text{JC}}$ , depends on how the power dissipation is distributed on the amplifier die.

DC output concentrates the power dissipation in one output transistor. AC output distributes the power dissipation equally between the two output transistors and therefore has lower thermal resistance. Similarly, the power dissipation may be all in one amplifier (worst case) or equally distributed between the two amplifiers (best case). Thermal resistances are provided for each of these possibilities. The case-to-junction temperature rise is the product of the power dissipation (total of both amplifiers) times the appropriate thermal resistance—

$$\Delta T_{\text{JC}} = (P_{\text{D total}}) (\theta_{\text{JC}}).$$

Sufficient heat sinking must be provided to keep the case temperature within safe limits for the maximum ambient temperature and power dissipation. The thermal resistance of the heat sink required may be calculated by:

$$\theta_{\text{HS}} = (150^\circ\text{C} - \Delta T_{\text{JC}} - T_A)/P_{\text{D}}$$

Commercially available heat sinks usually specify thermal resistance. These ratings are often suspect, however, since they depend greatly on the mounting environment and air flow conditions. Actual thermal performance should be verified by measurement of case temperature under the required load and environmental conditions.

No insulating hardware is required when using the OPA2541. Since mica and other similar insulators typically add  $0.7^\circ\text{C/W}$  thermal resistance, this is a significant advantage. See Burr-Brown Application Note AN-83 for further details on heat sinking.

### SAFE OPERATING AREA

The Safe Operating Area (SOA) curve provides comprehensive information on the power handling abilities of the OPA2541. It shows the allowable output current as a function of the voltage across the conducting output transistor (see Figure 1). This voltage is equal to the power supply voltage minus the output voltage. For example, as the amplifier output swings near the positive power supply voltage, the voltage across the output transistor decreases and the device can safely provide large output currents demanded by the load.

The internal current limit will not provide short-circuit protection in most applications. When the amplifier output is shorted to ground, the full power supply voltage is impressed across the conducting output transistor. For instance, with  $V_s = \pm 35V$ , a short circuit to ground would impress 35V across the conducting power transistor. The maximum safe output current at this voltage is 1.8A, so the internal current limit would not protect the amplifier. The unit-to-unit variation and temperature dependence of the internal current limit suggest that it be used to handle abnormal conditions and not activated in commonly encountered circuit operation.

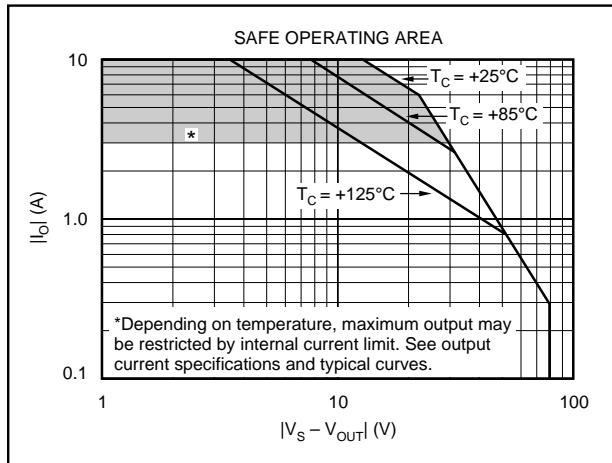


FIGURE 1. Safe Operating Area.

Reactive, or EMF generating loads such as DC motors can present demanding SOA requirements. With a purely reactive load, output voltage current occurs when the output voltage is zero and the voltage across the conducting transistor is equal to the full power supply voltage. See Burr-Brown Application Note AN-123 for further information on evaluating SOA.

Applications with inductive or EMF-generating loads which can produce "kick back" voltage surges to the amplifiers should include clamp diodes from the output terminals to the power supplies. These diodes should be chosen to limit the peak amplifier output voltage surges to less than 2V beyond the power supply rail voltage. Common 1A rated rectifier diodes will suffice in most applications.

## APPLICATIONS CIRCUITS

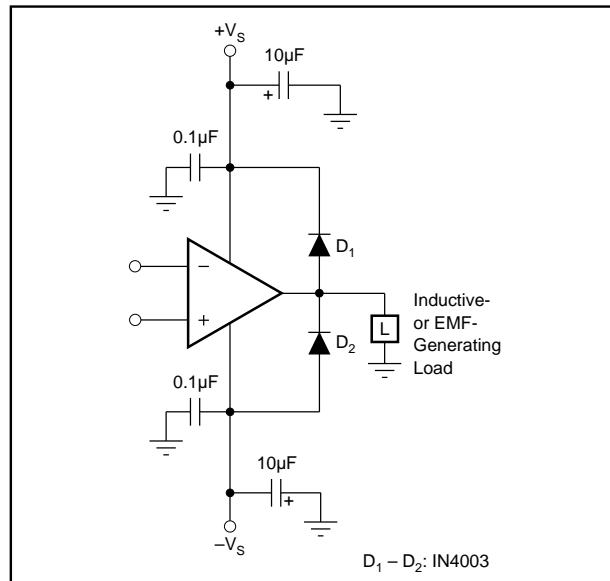


FIGURE 2. Clamping Output for EMF-Generating Loads.

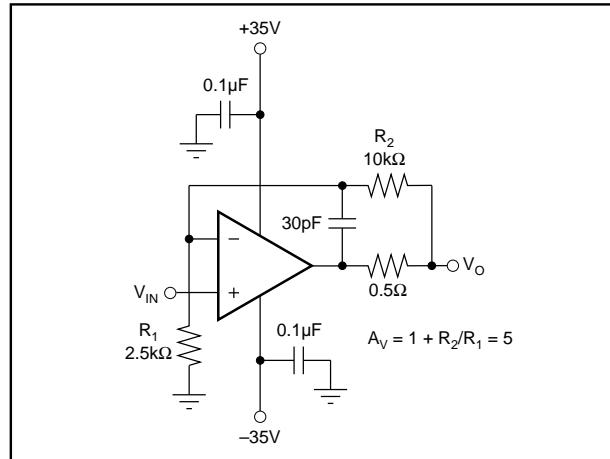


FIGURE 3. Isolating Capacitive Loads.

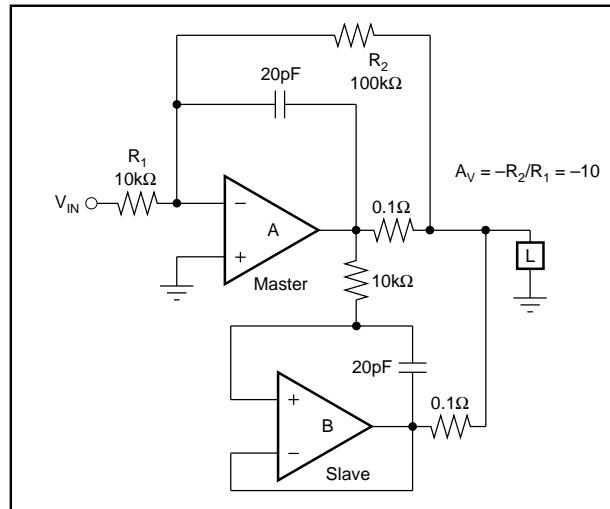


FIGURE 4. Paralleled Operation, Extended SOA.

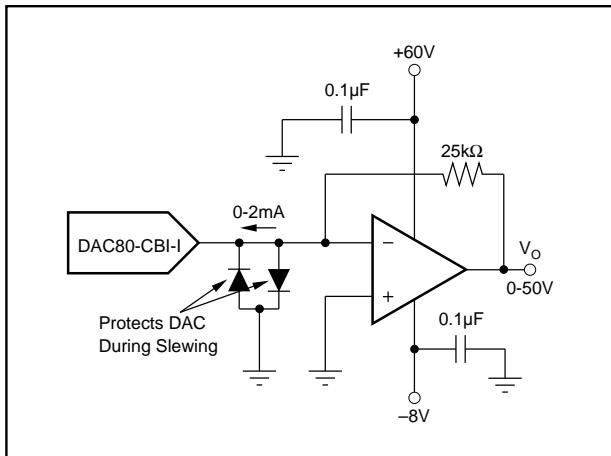


FIGURE 5. Programmable Voltage Source.

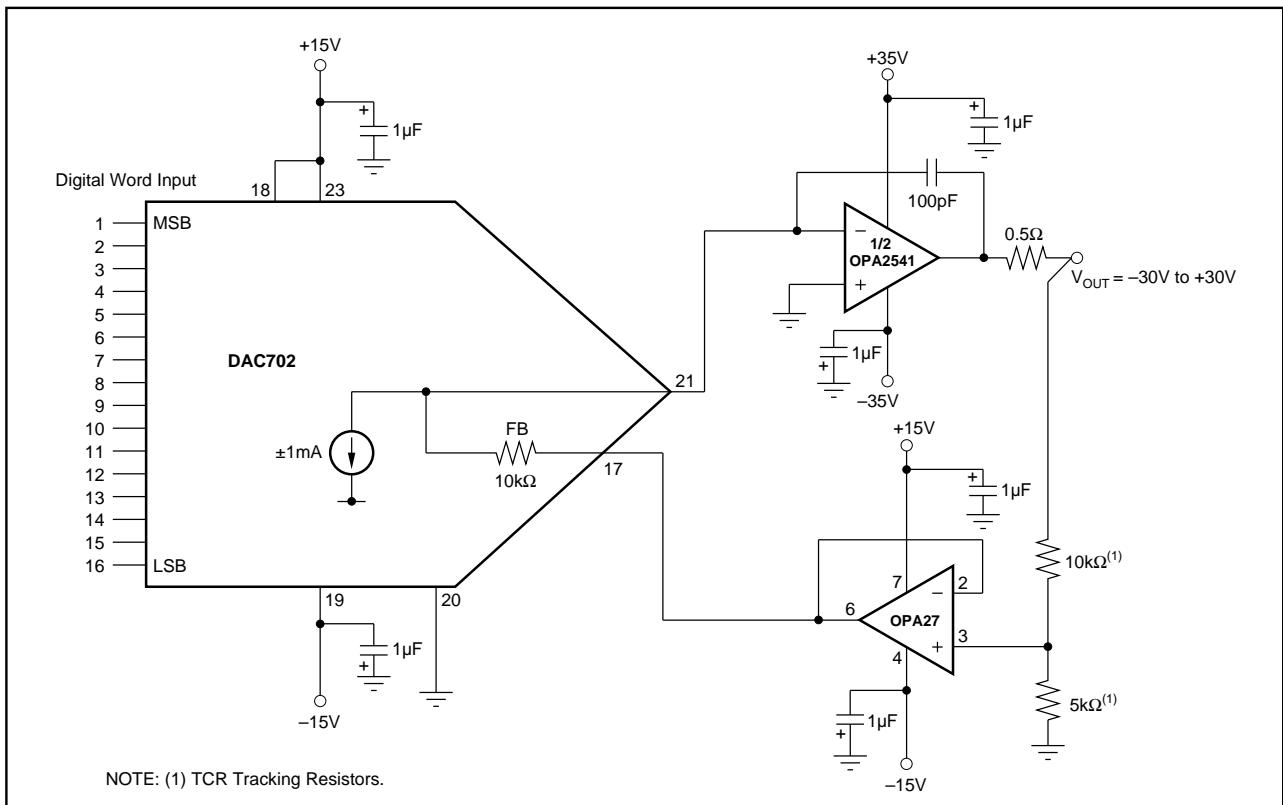
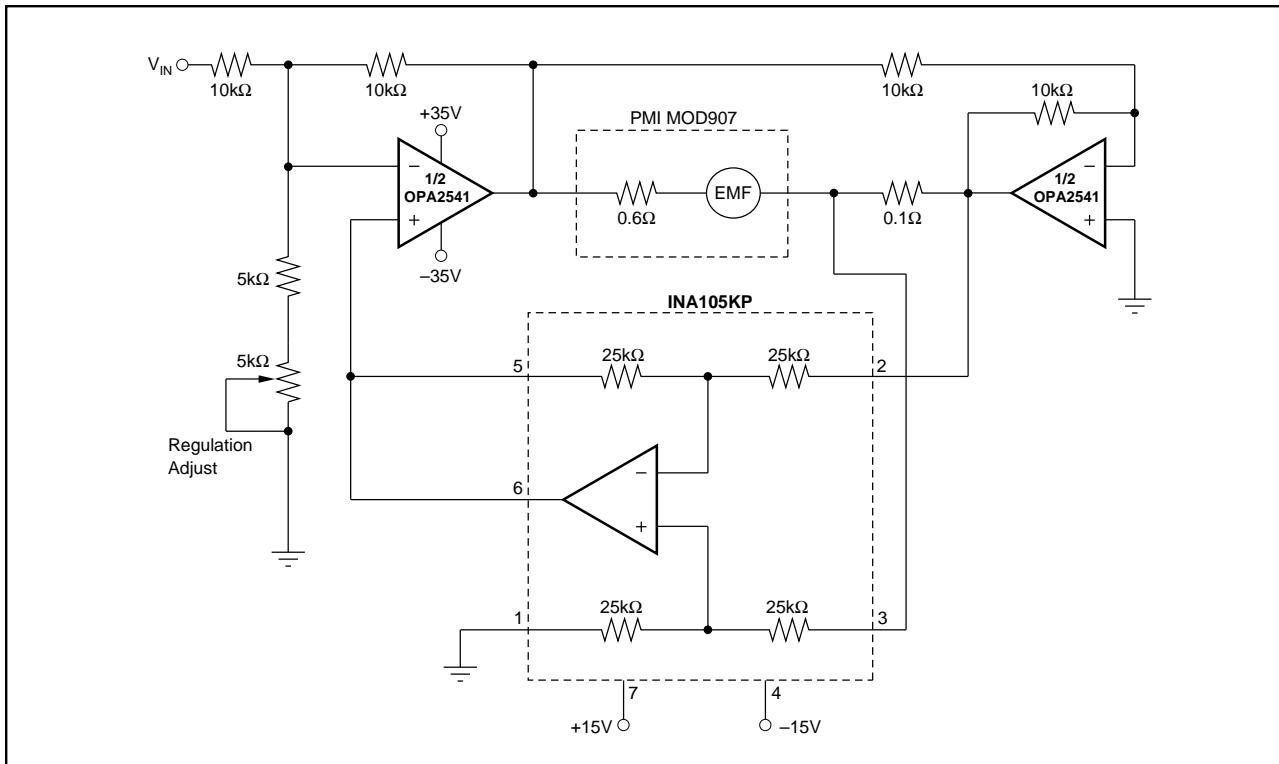


FIGURE 6. 16-Bit Programmable Voltage Source.



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FIGURE 7. Bridge Amplifier Motor-Speed Controller.

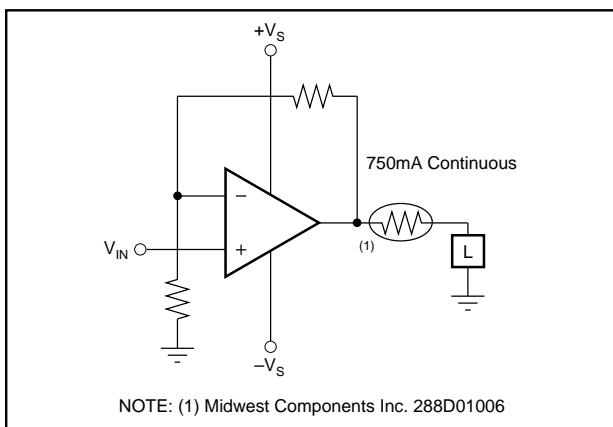


FIGURE 8. Limiting Output Current.

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">OPA2541AM</a>	Active	Production	TO-3 (LMF)   8	18   TUBE	Yes	Call TI	N/A for Pkg Type	-55 to 125	OPA2541AM
OPA2541AM.A	Active	Production	TO-3 (LMF)   8	18   TUBE	Yes	Call TI	N/A for Pkg Type	-55 to 125	OPA2541AM
<a href="#">OPA2541BM</a>	Active	Production	TO-3 (LMF)   8	18   TUBE	No	NI	N/A for Pkg Type	-55 to 125	OPA2541BM
OPA2541BM.A	Active	Production	TO-3 (LMF)   8	18   TUBE	No	NI	N/A for Pkg Type	-55 to 125	OPA2541BM
<a href="#">OPA2541SM</a>	Active	Production	TO-3 (LMF)   8	18   TUBE	Yes	Call TI	N/A for Pkg Type	-55 to 125	OPA2541SM
OPA2541SM.A	Active	Production	TO-3 (LMF)   8	18   TUBE	Yes	Call TI	N/A for Pkg Type	-55 to 125	OPA2541SM
<a href="#">OPA2541SMQ</a>	Active	Production	TO-3 (LMF)   8	18   TUBE	Yes	NI	N/A for Pkg Type	-40 to 125	OPA2541 OPA2541SMQ
OPA2541SMQ.A	Active	Production	TO-3 (LMF)   8	18   TUBE	Yes	NI	N/A for Pkg Type	-40 to 125	OPA2541 OPA2541SMQ

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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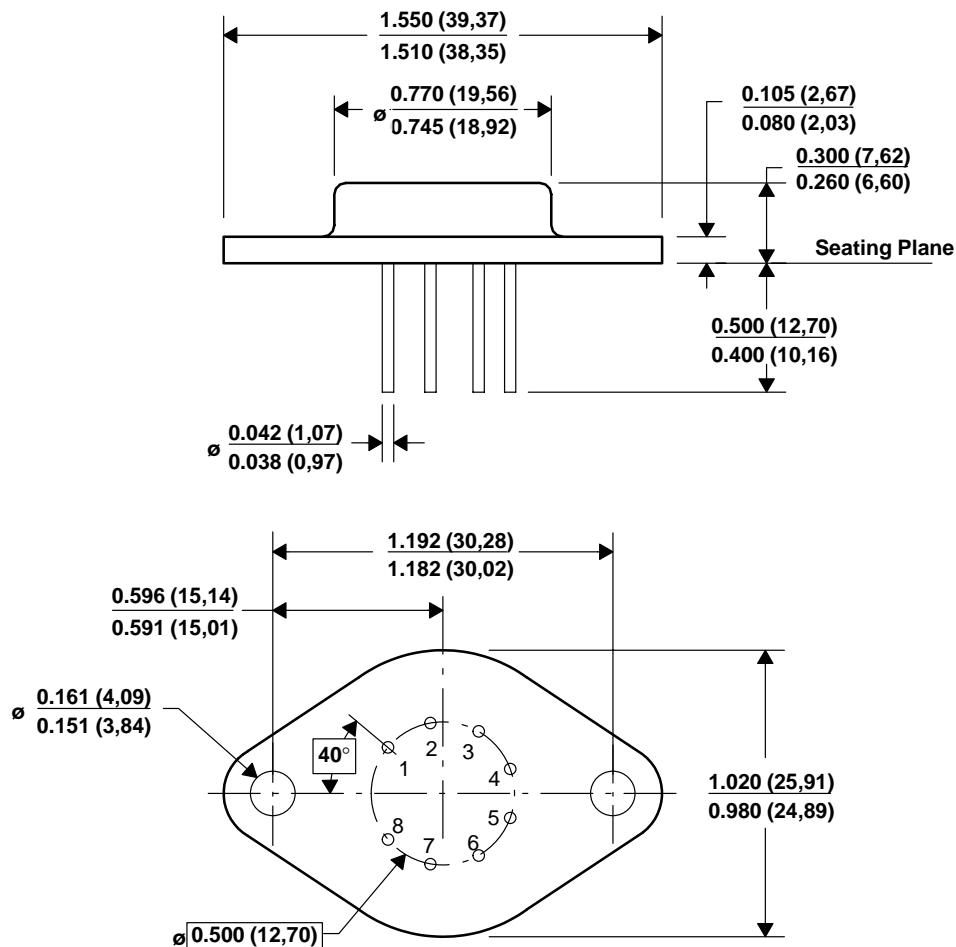
**TUBE**


\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
OPA2541AM	LMF	TO-CAN	8	18	532.13	21.59	889	NA
OPA2541AM.A	LMF	TO-CAN	8	18	532.13	21.59	889	NA
OPA2541BM	LMF	TO-CAN	8	18	532.13	21.59	889	NA
OPA2541BM.A	LMF	TO-CAN	8	18	532.13	21.59	889	NA
OPA2541SM	LMF	TO-CAN	8	18	532.13	21.59	889	NA
OPA2541SM.A	LMF	TO-CAN	8	18	532.13	21.59	889	NA
OPA2541SMQ	LMF	TO-CAN	8	18	532.13	21.59	889	NA
OPA2541SMQ.A	LMF	TO-CAN	8	18	532.13	21.59	889	NA

LMF (O-MBCY-W8)

METAL CYLINDRICAL PACKAGE



4202491/A 03/01

NOTES:

- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- Leads in true position within 0.010 (0.25) R @ MMC at seating plane.
- Pin numbers shown for reference only. Numbers may not be marked on package.

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